

SID

Factory: Rot am See

Article:

ML4

Provided:

Customer:

Date:

31.03.2026

WÜRTH
ELEKTRONIK
MORE THAN
YOU EXPECT

Processtechnology: B: undefined

| Material Text | Mat. Nr. | µm | Stackup | Process overview |
|---------------|----------|----|---------|------------------|
|---------------|----------|----|---------|------------------|

| | | | | | |
|--|----------|------|----|---|---------|
| A-RS Kupferfolie-018my 330x490mm | 50200238 | 18 | VS | 1 | A00 B00 |
| A-RAS-FR4-PP-7628-H45-TG150-HF-EM-37B... | 50203002 | 390 | | 2 | |
| C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B... | 50203001 | 0 | | 3 | |
| C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B... | 50203000 | 0 | | 4 | |
| B-STD-FR4-DS-1.575mm-018+018-TG150-HF... | 50203148 | 18 | L2 | | |
| | | 1539 | | 5 | |
| | | 18 | L3 | | |
| C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B... | 50203000 | 390 | | 6 | |
| C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B... | 50203001 | 0 | | 7 | |
| A-RAS-FR4-PP-7628-H45-TG150-HF-EM-37B... | 50203002 | 0 | | 8 | |
| A-RS Kupferfolie-018my 330x490mm | 50200238 | 18 | RS | 9 | |

Thickness after Pressing

B00:

2290 µm

Tol+:

240 µm

Tol-:

240 µm

Dmax:

2530 µm

Dmin:

2050 µm

Thickness over all

0 µm

Tol+:

0 µm

Tol-:

0 µm

Dmax:

0 µm

Dmin:

0 µm

Demand for customer

Thickness (D):

2400 µm

Tol+:

240 µm

Tol-:

240 µm

Dmax:

2640 µm

Dmin:

2160 µm

Measuring point: (05) over SM and galv. Cu; both sides

nominal:

2391 µm

Version 1.2.20.35

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